

IS31FL3742

30x6 DOTS MATRIX LED DRIVER

December 2017

GENERAL DESCRIPTION

The IS31FL3742 is a general purpose 30x6 LED Matrix programmed via an I2C compatible interface. Each LED can be dimmed individually with 8-bit PWM data and 8-bit scaling data which allowing 256 steps of linear PWM dimming and 256 steps of DC current adjustable level.

Additionally each LED open and short state can be detected, IS31FL3742 store the open or short information in Open-Short Registers. The Open-Short Registers allowing MCU to read out via I2C compatible interface. Inform MCU whether there are LEDs open or short and the locations of open or short LEDs.

The IS31FL3742 operates from 2.7V to 5.5V and features a very low shutdown and operational current.

IS31FL3742 is available in QFN-48 (6mmx6mm) package. It operates from 2.7V to 5.5V over the temperature range of -40°C to +125°C.

FEATURES

- Supply voltage range: 2.7V to 5.5V
- 30 Current Sink x 6 SW matrix size: drive up to 180 LEDs or 60 RGBs
- Individual 256 PWM control steps
- Individual 256 DC current steps
- Global 256 current setting
- SDB rising edge reset I2C module
- Programmable H/L logic: 1.4V/0.4V, 2.4V/0.6V
- 29kHz PWM frequency
- 1MHz I2C-compatible interface
- interrupt and state lookup registers
- Individual open and short error detect function
- De-ghost
- QFN-48 (6mmx6mm) package

APPLICATIONS

- Mobile phones and other hand-held devices for LED display
- Gaming device (Keyboard, mouse etc.)
- LED in write goods application
- Music box

TYPICAL APPLICATION CIRCUIT

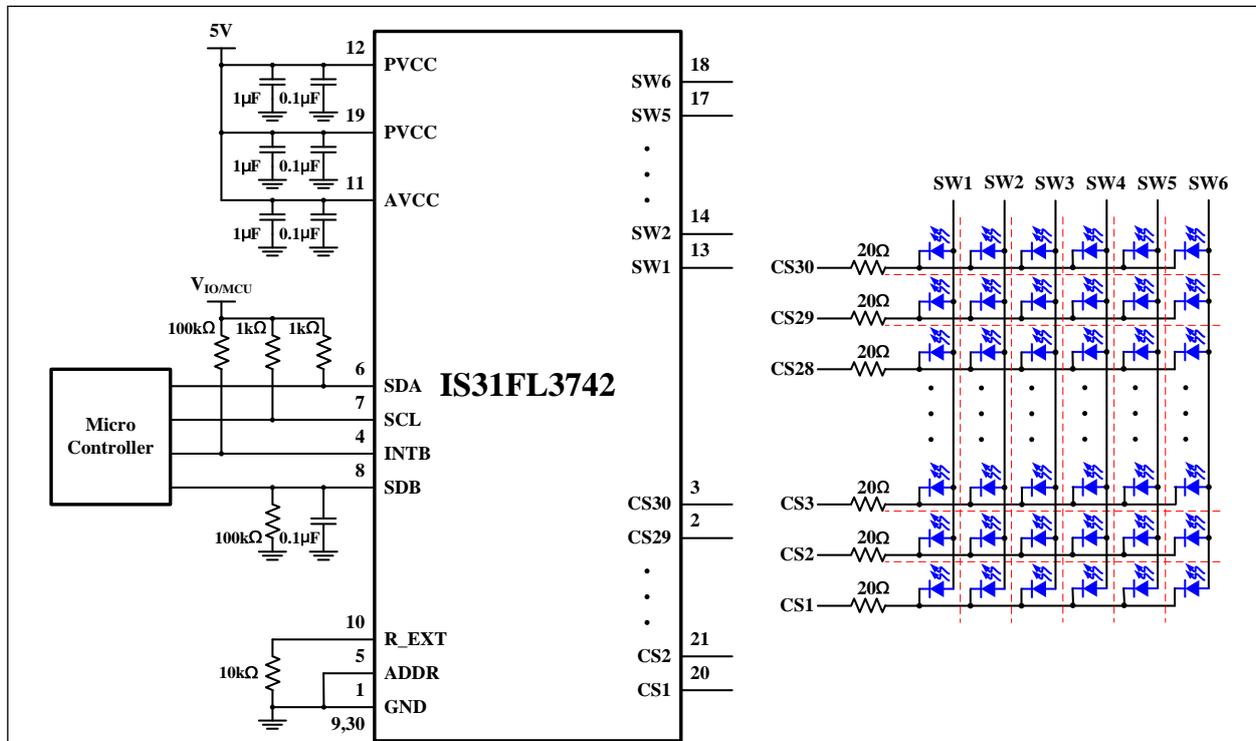


Figure 1 Typical Application Circuit (Single Color: 30x6)

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TYPICAL APPLICATION CIRCUIT (CONTINUED)

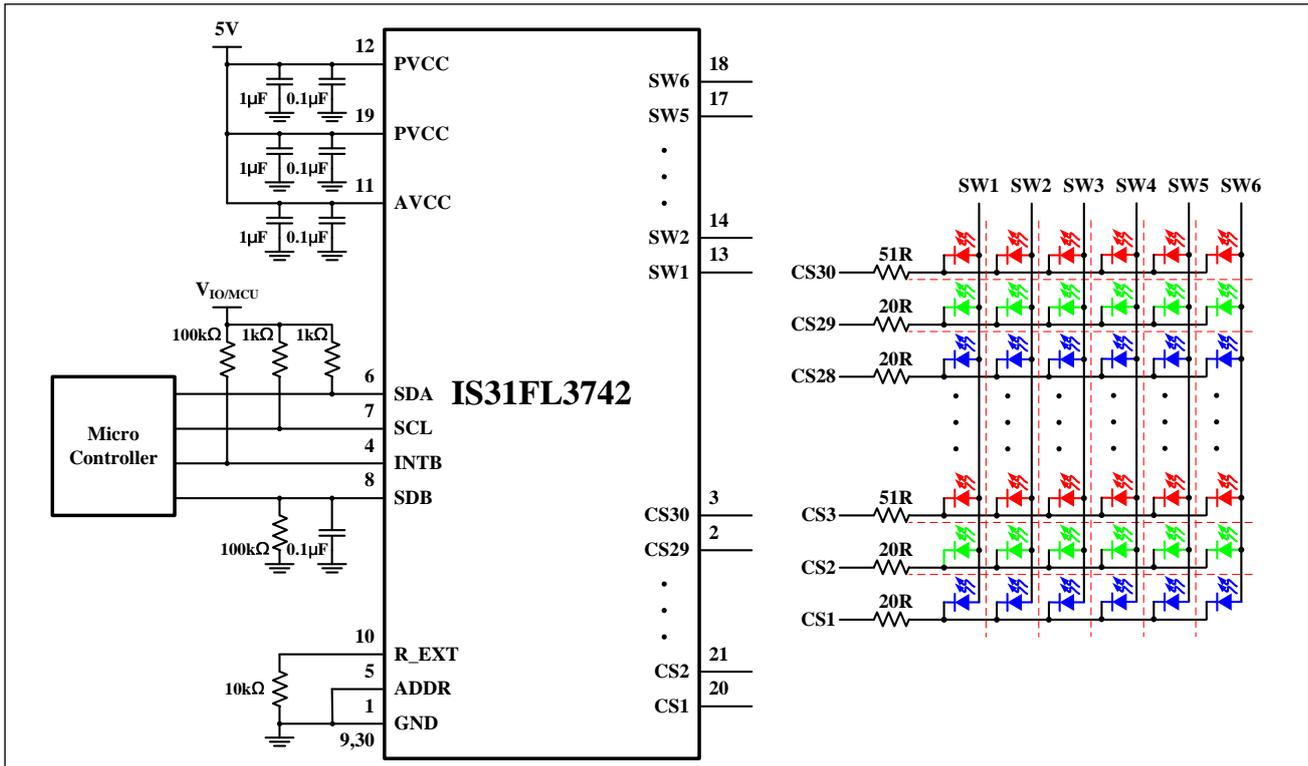
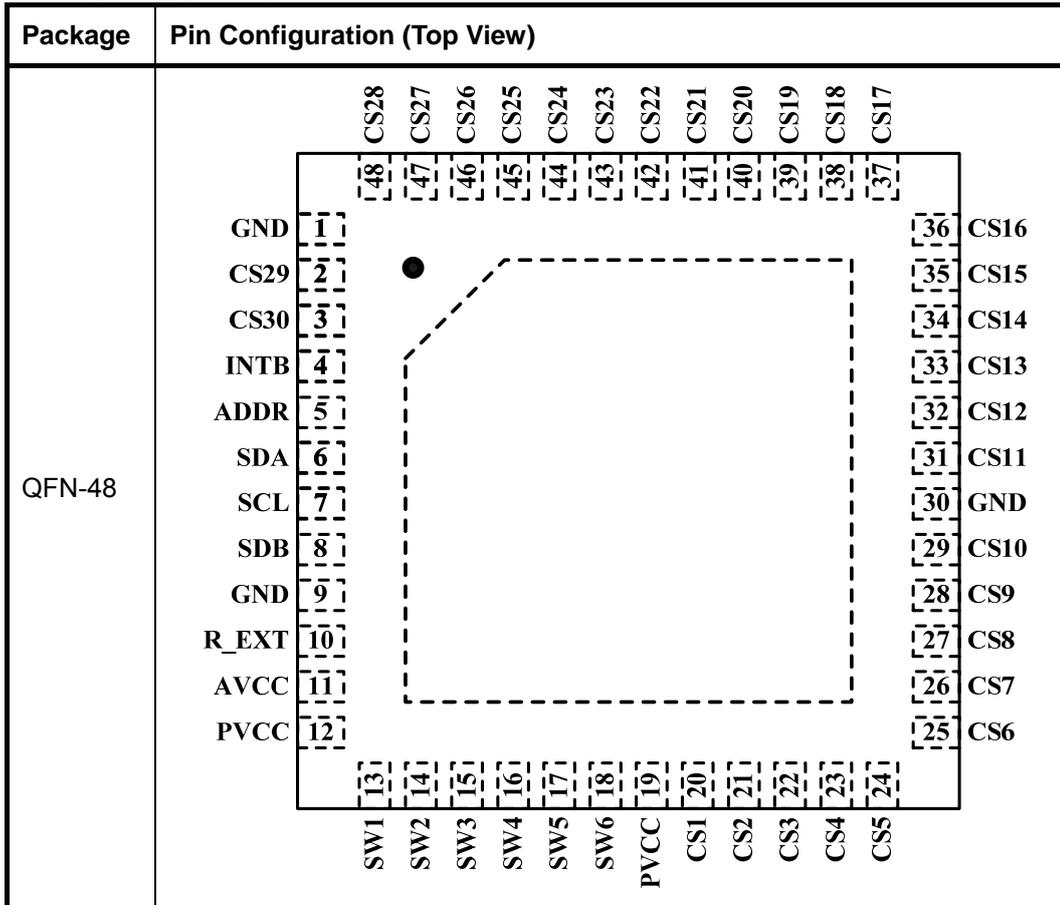


Figure 2 Typical Application Circuit (RGB Color: 10x6)

Note: For the mobile applications the IC should be placed far away from the mobile antenna in order to prevent the EMI.

IS31FL3742

PIN CONFIGURATION



PIN DESCRIPTION

| No. | Pin | Description |
|-----------------------|-------------|--|
| 1, 9, 30 | GND | Power GND (1, 30) and analog GND (9). |
| 20~29, 31~48, 2, 3 | CS1~CS30 | Current sink pin for LED matrix. |
| 4 | INTB | Interrupt output pin. Register F0h sets the function of the INTB pin and active low when the interrupt event happens. Can be NC (float) if interrupt function no used. |
| 5 | ADDR | I2C address select pin. |
| 6 | SDA | I2C compatible serial data. |
| 7 | SCL | I2C compatible serial clock. |
| 8 | SDB | Shutdown pin. |
| 10 | R_EXT | I _{OUT} setting register. |
| 11 | AVCC | Power for analog and digital circuits. |
| 12,19 | PVCC | Power for current source. |
| 13~18 | SW1~SW6 | Source/switch pin for LED matrix. |
| | Thermal Pad | Need to connect to GND pins in PCB. |



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ORDERING INFORMATION

Industrial Range: -40°C to +125°C

| Order Part No. | Package | QTY/Reel |
|---------------------|-------------------|----------|
| IS31FL3742-QFLS4-TR | QFN-48, Lead-free | 2500 |

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ABSOLUTE MAXIMUM RATINGS

| | |
|--|-----------------------|
| Supply voltage, V_{CC} | -0.3V ~ +6.0V |
| Voltage at any input pin | -0.3V ~ $V_{CC}+0.3V$ |
| Maximum junction temperature, T_{JMAX} | +150°C |
| Storage temperature range, T_{STG} | -65°C ~ +150°C |
| Operating temperature range, $T_A=T_J$ | -40°C ~ +125°C |
| Package thermal resistance, junction to ambient (4 layer standard test PCB based on JEDEC standard), θ_{JA} | 37.84°C/W |
| ESD (HBM) for SWx pins | ±2kV |
| ESD (HBM) for other pins | ±5kV |
| ESD (CDM) | ±1kV |

Note:

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

The following specifications apply for $V_{CC} = 3.6V$, $T_A = 25^\circ C$, unless otherwise noted.

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------------------|---|---|-------|------|-------|---------|
| V_{CC} | Supply voltage | | 2.7 | | 5.5 | V |
| I_{CC} | Quiescent power supply current | $V_{SDB}=V_{CC}$, all LEDs off | | 3.8 | | mA |
| I_{SD} | Shutdown current | $V_{SDB}=0V$ | | 1.2 | | μA |
| | | $V_{SDB}=V_{CC}$, Configuration Register written “0000 0000” | | 1.2 | | |
| $I_{OUT(PEAK)}$ | Maximum constant current of CS1~CS30 | $R_{EXT}=10k\Omega$, GCC=0xFF, SL=0xFF | 35.34 | 38 | 40.66 | mA |
| | | $R_{EXT}=16.5k\Omega$, GCC=0xFF, SL=0xFF | 21.39 | 23 | 24.61 | mA |
| ΔI_{MATCH} | Output peak current mismatch between channels | $R_{EXT}=10k\Omega$, GCC=0xFF, SL=0xFF (Note 1) | -6 | | 6 | % |
| I_{LED} | Average current on each LED $I_{LED} = I_{OUT(PEAK)}/6.75$ | $R_{EXT}=10k\Omega$, GCC=0xFF, SL=0xFF | | 5.63 | | mA |
| V_{HR} | Current switch headroom voltage SW1~SW6 | $I_{SWITCH}=800mA$ (Note 2,3) | | 400 | | mV |
| | Current sink headroom voltage CS1~CS30 | $I_{SINK}=38mA$ (Note 2) | | 300 | | |
| t_{SCAN} | Period of SWx scanning | | | 32 | | μs |
| t_{NOL1} | Non-overlap blanking time 1 during scan, the SWx are all off during this time | | | 2 | | μs |
| t_{NOL2} | Delay total time for CS1 to CS 30, during this time, the SWx is on but CSx is not all turned on | | | 2 | | μs |

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ELECTRICAL CHARACTERISTICS (CONTINUE)

The following specifications apply for $V_{CC} = 3.6V$, $T_A = 25^\circ C$, unless otherwise noted.

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---|----------------------------------|-------------------------|------|------|------|------|
| Logic Electrical Characteristics (SDA, SCL, ADDR, SDB) | | | | | | |
| V_{IL} | Logic "0" input voltage | $V_{CC}=2.7V, LGC=0$ | | | 0.4 | V |
| | | $V_{CC}=2.7V, LGC=1$ | | | 0.6 | |
| V_{IH} | Logic "1" input voltage | $V_{CC}=5.5V, LGC=0$ | 1.4 | | | V |
| | | $V_{CC}=5.5V, LGC=1$ | 2.4 | | | |
| V_{HYS} | Input schmitt trigger hysteresis | $V_{CC}=3.6V, LGC=0$ | | 0.2 | | V |
| | | $V_{CC}=3.6V, LGC=1$ | | 0.2 | | |
| I_{IL} | Logic "0" input current | $V_{INPUT}= L$ (Note 4) | | 5 | | nA |
| I_{IH} | Logic "1" input current | $V_{INPUT}= H$ (Note 4) | | 5 | | nA |

DIGITAL INPUT SWITCHING CHARACTERISTICS (NOTE 4)

| Symbol | Parameter | Fast Mode | | | Fast Mode Plus | | | Units |
|---------------|--|-----------|------|------|----------------|------|------|---------|
| | | Min. | Typ. | Max. | Min. | Typ. | Max. | |
| f_{SCL} | Serial-clock frequency | - | | 400 | - | | 1000 | kHz |
| t_{BUF} | Bus free time between a STOP and a START condition | 1.3 | | - | 0.5 | | - | μs |
| $t_{HD, STA}$ | Hold time (repeated) START condition | 0.6 | | - | 0.26 | | - | μs |
| $t_{SU, STA}$ | Repeated START condition setup time | 0.6 | | - | 0.26 | | - | μs |
| $t_{SU, STO}$ | STOP condition setup time | 0.6 | | - | 0.26 | | - | μs |
| $t_{HD, DAT}$ | Data hold time | - | | - | - | | - | μs |
| $t_{SU, DAT}$ | Data setup time | 100 | | - | 50 | | - | ns |
| t_{LOW} | SCL clock low period | 1.3 | | - | 0.5 | | - | μs |
| t_{HIGH} | SCL clock high period | 0.7 | | - | 0.26 | | - | μs |
| t_R | Rise time of both SDA and SCL signals, receiving | - | | 300 | - | | 120 | ns |
| t_F | Fall time of both SDA and SCL signals, receiving | - | | 300 | - | | 120 | ns |

Note 1: $\Delta I_{MATCH} = (I_{OUT(PEAK)} - I_{AVG(PEAK)}) / I_{AVG(PEAK)} \times 100\%$. $I_{AVG(PEAK)} = (I_{OUT(PEAK)1} + I_{OUT(PEAK)2} + \dots + I_{OUT(PEAK)30}) / 30$

Note 2: Global Current Control Register (GCC, PG4, 01h) written "1111 1111", SL written "1111 1111", $R_{EXT} = 10k\Omega$.

Note 3: All LEDs are on and PWM="1111 1111", GCC = "0xFF".

Note 4: Guaranteed by design.

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DETAILED DESCRIPTION

I2C INTERFACE

The IS31FL3742 uses a serial bus, which conforms to the I2C protocol, to control the chip's functions with two wires: SCL and SDA. The IS31FL3742 has a 7-bit slave address (A7:A1), followed by the R/W bit, A0. Set A0 to "0" for a write command and set A0 to "1" for a read command. The value of bits A1 and A2 are decided by the connection of the ADDR pin.

Table 1 Slave Address:

| Bit | A7:A3 | A2:A1 | A0 |
|-------|-------|-------|-----|
| Value | 01100 | ADDR | 0/1 |

ADDR connects to GND, ADDR= 00;
 ADDR connects to VCC, ADDR= 11;
 ADDR connects to SCL, ADDR= 01;
 ADDR connects to SDA, ADDR= 10;

The SCL line is uni-directional. The SDA line is bi-directional (open-collector) with a pull-up resistor (typically 400kHz IIC with 4.7kΩ, 1MHz IIC with 1kΩ). The maximum clock frequency specified by the I2C standard is 1MHz. In this discussion, the master is the microcontroller and the slave is the IS31FL3742.

The timing diagram for the I2C is shown in Figure 4. The SDA is latched in on the stable high level of the SCL. When there is no interface activity, the SDA line should be held high.

The "START" signal is generated by lowering the SDA signal while the SCL signal is high. The start signal will alert all devices attached to the I2C bus to check the incoming address against their own chip address.

The 8-bit chip address is sent next, most significant bit first. Each address bit must be stable while the SCL level is high.

After the last bit of the chip address is sent, the master checks for the IS31FL3742's acknowledge. The master releases the SDA line high (through a pull-up resistor). Then the master sends a SCL pulse. If the IS31FL3742 has received the address correctly, then it holds the SDA line low during the SCL pulse. If the SDA line is not low, then the master should send a "STOP" signal (discussed later) and abort the transfer.

Following acknowledge of IS31FL3742, the register address byte is sent, most significant bit first. IS31FL3742 must generate another acknowledge indicating that the register address has been received.

Then 8-bit of data byte are sent next, most significant bit first. Each data bit should be valid while the SCL level is stable high. After the data byte is sent, the IS31FL3742 must generate another acknowledge to indicate that the data was received.

The "STOP" signal ends the transfer. To signal "STOP", the SDA signal goes high while the SCL signal is high.

ADDRESS AUTO INCREMENT

To write multiple bytes of data into IS31FL3742, load the address of the data register that the first data byte is intended for. During the IS31FL3742 acknowledge of receiving the data byte, the internal address pointer will increment by one. The next data byte sent to IS31FL3742 will be placed in the new address, and so on. The auto increment of the address will continue as long as data continues to be written to IS31FL3742 (Figure 7).

READING OPERATION

Most of the registers can be read.

To read the FCh, FEh F0h and F1h, after I2C start condition, the bus master must send the IS31FL3742 device address with the R/\bar{W} bit set to "0", followed by the register address (FEh or F1h) which determines which register is accessed. Then restart I2C, the bus master should send the IS31FL3742 device address with the R/\bar{W} bit set to "1". Data from the register defined by the command byte is then sent from the IS31FL3742 to the master (Figure 8).

To read the registers of Page 0 thru Page 5, the FDh should write with 00h before follow the Figure 8 sequence to read the data. That means, when you want to read register of Page 0, the FDh should point to Page 0 first and you can read the Page 0 data.

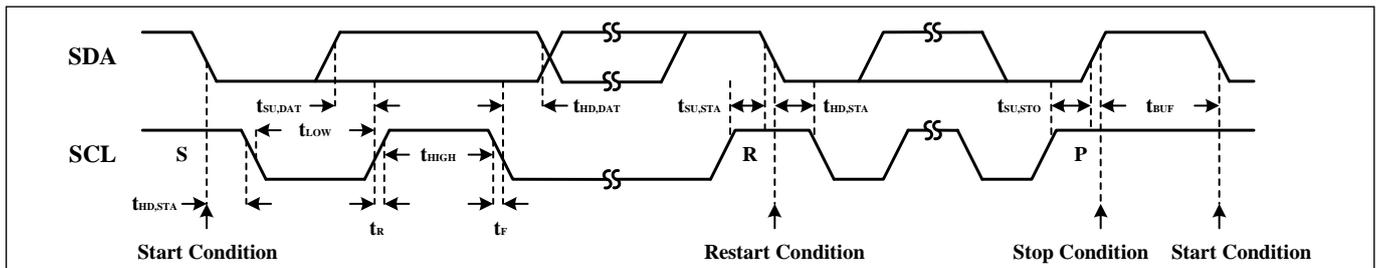


Figure 4 Interface Timing

IS31FL3742

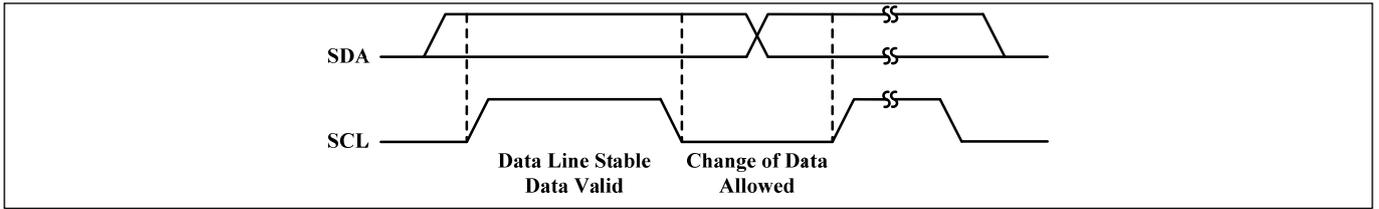


Figure 5 Bit Transfer

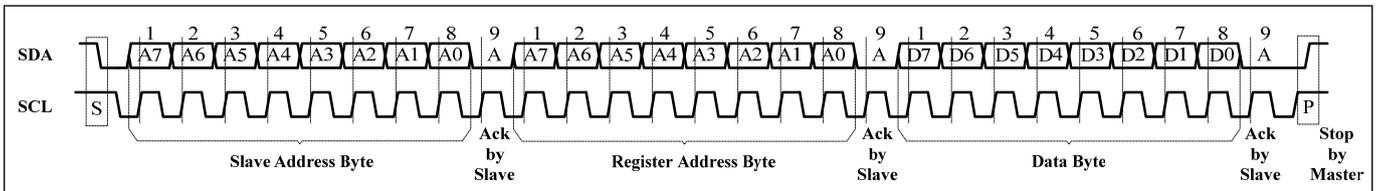


Figure 6 Writing to IS31FL3742 (Typical)

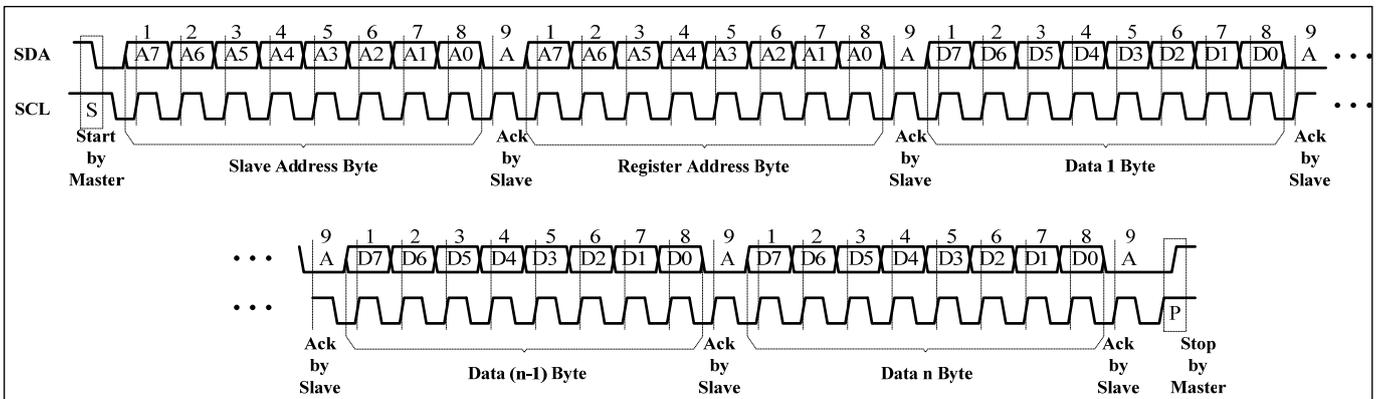


Figure 7 Writing to IS31FL3742 (Automatic Address Increment)

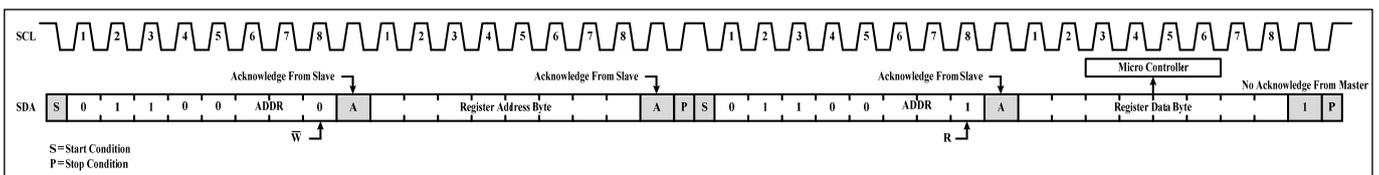


Figure 8 Reading from IS31FL3742

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Table 2 Register Definition-1

| Address | Name | Function | Table | R/W | Default |
|---------|-----------------------------|---|-------|-----|---------------|
| FDh | Command Register | Available Page 0, Page 2 and Page 4 Registers | 3 | W | 0000 0000 |
| FEh | Command Register Write Lock | To lock/unlock Command Register | 4 | R/W | 0000 0000 |
| F0h | Interrupt Mask Register | Configure the interrupt function | 5 | W | |
| F1h | Interrupt Status Register | Show the interrupt status | 6 | R | |
| FCh | ID Register | For read the product ID only | - | R | Slave address |

REGISTER CONTROL

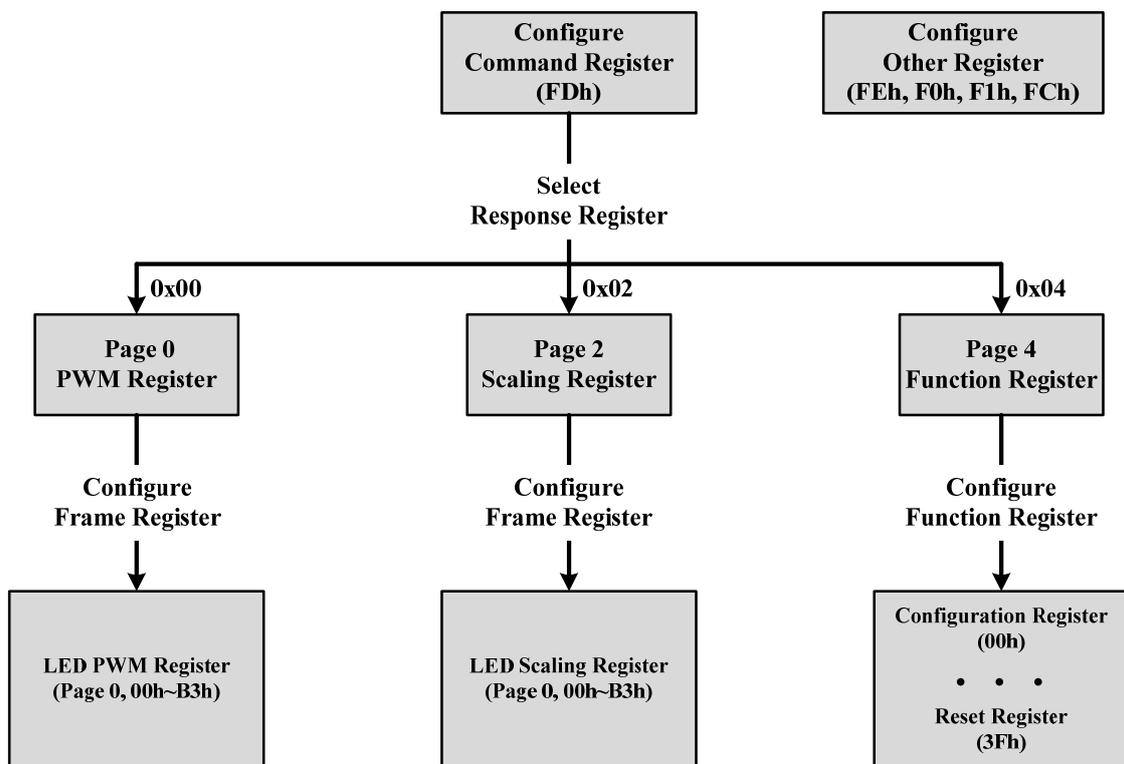


Table 3 FDh Command Register (Write Only)

| Data | Function |
|-----------|---|
| 0000 0000 | Point to Page 0 (PG0, PWM Register is available) |
| 0000 0010 | Point to Page 2 (PG2, Scaling (SL) Register is available) |
| 0000 0100 | Point to Page 4 (PG4, Function Register is available) |
| Others | Not allowed |

Note: FDh is locked when power up, need to unlock this register before write command to it. See Table 4 for detail.

The Command Register should be configured first after writing in the slave address to choose the available register. Then write data in the choosing register. Power up default state is "0000 0000".

For example, when write "0000 0010" in the Command Register (FDh), the data which writing after will be stored in the page 2 Registers. Write new data can configure other frame position.

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Table 4 FEh Command Register Write Lock (Read/Write)

| Bit | D7:D0 |
|---------|-----------|
| Name | CRWL |
| Default | 0000 0000 |

To select the PG0, PG2 and PG4, need to unlock this register first, with the purpose to avoid mis-operation of this register. When FEh is written with 0xC5, FDh is allowed to modify once, after the FDh is modified the FEh will reset to be 0x00 at once.

CRWL Command Register Write Lock
 0000 0000 FDh write disable
 1100 0101 FDh write enable once

Table 5 F0h Interrupt Mask Register

| Bit | D7:D5 | D4 | D3:D2 | D1 | D0 |
|---------|-------|-----|-------|----|----|
| Name | - | IAC | - | IS | IO |
| Default | 000 | 0 | 00 | 0 | 0 |

Configure the interrupt function for IC.

IAC Auto Clear Interrupt Bit
 0 Interrupt could not auto clear
 1 Interrupt auto clear when INTB stay low exceeds 8ms

IS Dot Short Interrupt Bit
 0 Disable dot short interrupt
 1 Enable dot short interrupt

IO Dot Open Interrupt Bit
 0 Disable dot open interrupt
 1 Enable dot open interrupt

Table 6 F1h Interrupt Status Register (Read Only)

| Bit | D7:D2 | D1 | D0 |
|---------|---------|----|----|
| Name | - | SB | OB |
| Default | 0000 00 | 0 | 0 |

Show the interrupt status for IC.

SB Short Bit
 0 No short
 1 Short happens

OB Open Bit
 0 No open
 1 Open happens

FCh ID Register

ID register is read only and read result is the device slave address. For example, if ADDR pin connects to GND, read result is 0x60.

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Table 7 Register Definition-2

| Address | Name | Function | Table | R/W | Default |
|---|--|---|-------|-----|-----------|
| PG0 (0x00): PWM Register | | | | | |
| 00h~B3h | PWM Register | Set PWM for each LED | 8 | R/W | 0000 0000 |
| PG2 (0x02): LED Scaling ($I_{OUT(PEAK)}$ DC current adjust) | | | | | |
| 00h~B3h | Scaling Register | Set Scaling for each LED | 9 | R/W | 0000 0000 |
| PG4 (0x04): Function Register | | | | | |
| 00h | Configuration Register | Configure the operation mode | 11 | R/W | 0000 0000 |
| 01h | Global Current Control Register | Set the global current | 12 | R/W | 0000 0000 |
| 02h | Pull Down/Up Resistor Selection Register | Set the pull down resistor for SWx and the pull up resistor for CSy | 13 | R/W | 0101 0101 |
| 03h~1Fh | Open/Short storage | Store the open or short information | 14 | R | 0000 0000 |
| 3Fh | Reset Register | Reset all register to POR state | - | W | 0000 0000 |

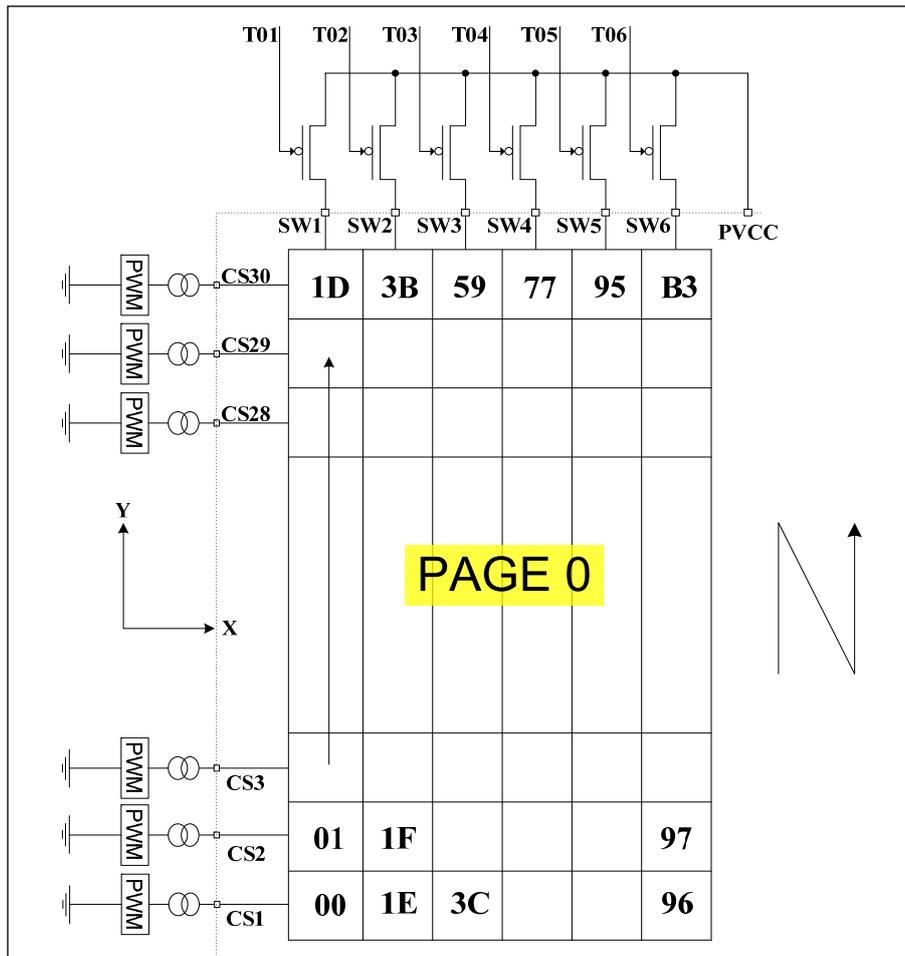


Figure 9 PWM Register

Table 8 00h ~ B3h PWM Register

| Bit | D7:D0 |
|---------|-----------|
| Name | PWM |
| Default | 0000 0000 |

Each dot has a byte to modulate the PWM duty in 256 steps.

The value of the PWM Registers decides the average current of each LED noted I_{LED} .

I_{LED} computed by Formula (1):

$$I_{LED} = \frac{PWM}{256} \times I_{OUT(PEAK)} \times Duty \quad (1)$$

$$PWM = \sum_{n=0}^7 D[n] \cdot 2^n$$

Where Duty is the duty cycle of SWx,

$$Duty = \frac{32\mu s}{(32\mu s + 2\mu s + 2\mu s)} \times \frac{1}{6} = \frac{1}{6.75} \quad (2)$$

I_{OUT} is the output current of CSy (y=1~30),

$$I_{OUT(PEAK)} = \frac{383}{R_{EXT}} \times \frac{GCC}{256} \times \frac{SL}{256} \quad (3)$$

GCC is the Global Current Control Register (PG4, 01h) value, SL is the Scaling Register value and R_{EXT} is the external resistor of R_EXT pin. D[n] stands for the individual bit value, 1 or 0, in location n.

For example: if D7:D0=1011 0101 (0xB5, 181), GCC=0xFF, R_{EXT} =10kΩ, SL=0xFF

$$I_{LED} = \frac{383}{10k\Omega} \times \frac{255}{256} \times \frac{255}{256} \times \frac{1}{6.75} \times \frac{181}{256} = 3.98mA$$

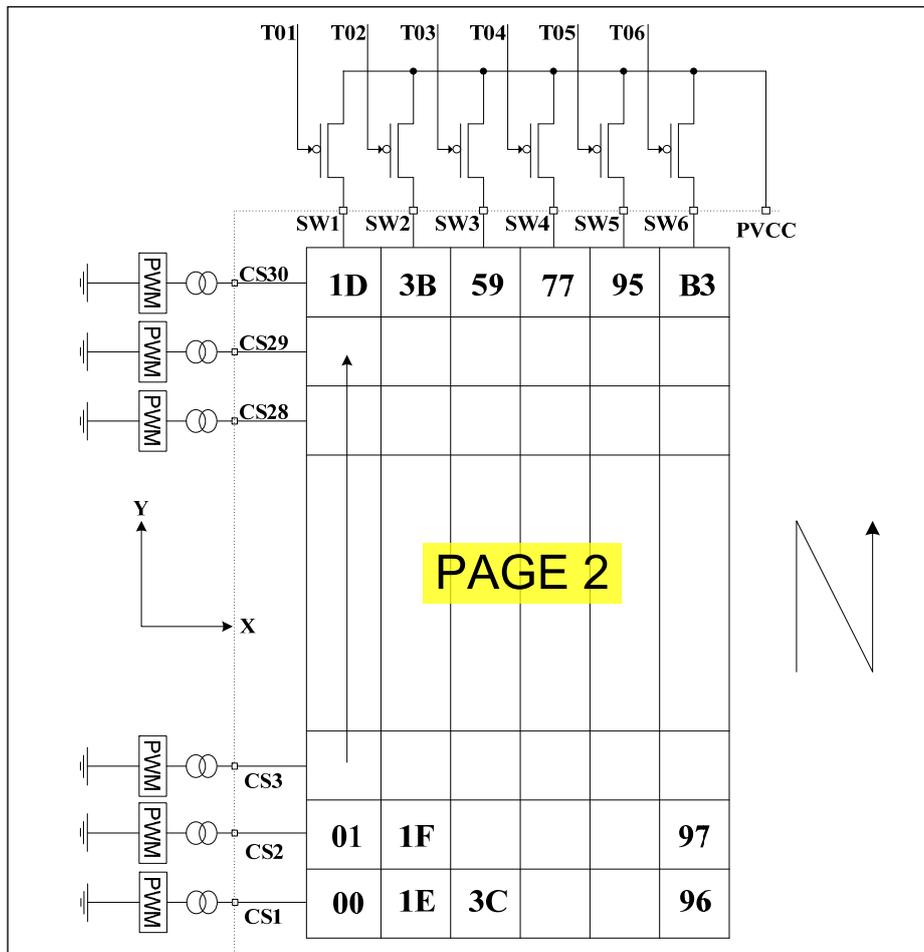


Figure 10 Scaling Register

Table 9 00h ~ B3h Scaling Register

| Bit | D7:D0 |
|---------|-----------|
| Name | SL |
| Default | 0000 0000 |

Scaling register control the DC output current of each dot. Each dot has a byte to modulate the scaling in 256 steps.

The value of the Scaling Registers decides the peak current of each LED noted I_{OUT} .

I_{OUT} computed by Formula (3):

$$I_{OUT(PEAK)} = \frac{383}{R_{EXT}} \times \frac{GCC}{256} \times \frac{SL}{256} \quad (3)$$

$$SL = \sum_{n=0}^7 D[n] \cdot 2^n$$

I_{OUT} is the output current of CS_y (y=1~30), GCC is the Global Current Control Register (PG4, 01h) value and R_{EXT} is the external resistor of R_EXT pin. D[n] stands for the individual bit value, 1 or 0, in location n.

For example: if $R_{EXT}=10k\Omega$, $GCC=0xFF$, $SL=0x7F$,

$$SL = \sum_{n=0}^7 D[n] \cdot 2^n = 127$$

$$I_{OUT(PEAK)} = \frac{383}{10k\Omega} \times \frac{255}{256} \times \frac{127}{256} = 18.78mA$$

$$I_{LED} = 18.78mA \times \frac{1}{6.75} \times \frac{PWM}{256} = 2.95mA \times \frac{PWM}{256}$$

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Table 10 Page 4 (PG4, 0x04): Function Register

| Register | Name | Function | Table | R/W | Default |
|----------|--|---|-------|-----|-----------|
| 00h | Configuration Register | Configure the operation mode | 11 | R/W | 0000 0000 |
| 01h | Global Current Control Register | Set the global current | 12 | R/W | 0000 0000 |
| 02h | Pull Down/Up Resistor Selection Register | Set the pull down resistor for SWx and the pull up resistor for CSy | 13 | R/W | 0101 0101 |
| 03h~1Fh | Open/Short storage | Store the open or short information | 14 | R | 0000 0000 |
| 3Fh | Reset Register | Reset all register to POR state | - | W | 0000 0000 |

Table 11 00h Configuration Register

| Bit | D7:D4 | D3 | D2:D1 | D0 |
|---------|-------|-----|-------|-----|
| Name | SWS | LGC | OSDE | SSD |
| Default | 0000 | 0 | 00 | 0 |

The Configuration Register sets operating mode of IS31FL3742.

SSD Software Shutdown Control
 0 Software shutdown
 1 Normal operation

OSDE Open Short Detection Enable
 00/11 Disable open/short detection
 01 Enable open detection
 10 Enable short detection

LGC H/L logic
 0 1.4V/0.4V
 1 2.4V/0.6V

SWS SWx Setting
 0000 SW1~SW6, 1/9
 0001 SW1~SW6, 1/8
 0010 SW1~SW6, 1/7
 0011 SW1~SW6, 1/6
 0100 SW1~SW5, 1/5, SW6 no-active
 0101 SW1~SW4, 1/4, SW5~SW6 no-active
 0110 SW1~SW3, 1/3, SW4~SW6 no-active
 0111 SW1~SW2, 1/2, SW3~SW6 no-active
 1000 All CSx work as current sinks only, no scan
 Others 1/9

When OSDE set to "01", open detection will be trigger once, the user could trigger open detection again by set OSDE from "00" to "01".

When OSDE set "10", short detection will be trigger once, the user could trigger short detection again by set OSDE from "00" to "10".

When SSD is "0", IS31FL3742 works in software shutdown mode and to normal operate the SSD bit should set to "1".

SWS control the duty cycle of the SW, for 1/6 duty cycle, the SWS must set to "0011".

Table 12 01h Global Current Control Register

| Bit | D7:D0 |
|---------|-----------|
| Name | GCCx |
| Default | 0000 0000 |

The Global Current Control Register modulates all CSy (x=1~30) DC current which is noted as I_{OUT} in 256 steps.

I_{OUT} is computed by the Formula (3):

$$I_{OUTPEAK} = \frac{383}{R_{EXT}} \times \frac{GCC}{256} \times \frac{SL}{256} \quad (3)$$

$$GCC = \sum_{n=0}^7 D[n] \cdot 2^n$$

Where D[n] stands for the individual bit value, 1 or 0, in location n.

Table 13 02h Pull Down/Up Resistor Selection Register

| Bit | D7 | D6:D4 | D3 | D2:D0 |
|---------|----|-------|----|-------|
| Name | - | PDR | - | PUR |
| Default | 0 | 101 | 0 | 101 |

Set pull down resistor for SWx and pull up resistor for CSy.

PUR CSy Pull Up Resistor Selection Bit
 000 No pull up resistor
 001 0.5kΩ
 010 1.0kΩ
 011 2.0kΩ
 100 4.0kΩ
 101 8.0kΩ
 110 16kΩ
 111 32kΩ

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| | |
|------------|--------------------------------------|
| PDR | SWx Pull Down Resistor Selection Bit |
| 000 | No pull down resistor |
| 001 | 0.5kΩ |
| 010 | 1.0kΩ |
| 011 | 2.0kΩ |
| 100 | 4.0kΩ |
| 101 | 8.0kΩ |
| 110 | 16kΩ |
| 111 | 32kΩ |

Table 14-1 Open/Short Register

03h~05h Open/Short Information
 06h~0Ah Open/Short Information
 0Bh~0Fh Open/Short Information
 10h~14h Open/Short Information
 15h~19h Open/Short Information
 1Ch~1Eh Open/Short Information

| Bit | D7:D0 |
|---------|--|
| Name | CS8:CS1; CS16:CS09;CS24:CS17(MSB:LSB) |
| Default | 0000 0000 |

06h Open/Short Information
 0Bh Open/Short Information
 10h Open/Short Information
 15h Open/Short Information
 1Ah Open/Short Information
 1Fh Open/Short Information

Table 14-2 Open/Short Register

| Bit | D7:D6 | D5:D0 |
|---------|-------|-----------|
| Name | - | CS30:CS25 |
| Default | 00 | 00 0000 |

When OSDE (PG4, 00h) set to "01", open detection will be trigger once, and the open information will be store at 03h~1Fh

When OSDE (PG4, 00h) set to "10", short detection will be trigger once, and the short information will be store at 03h~1Fh

Before set OSDE, the GCC should set to 0x01.

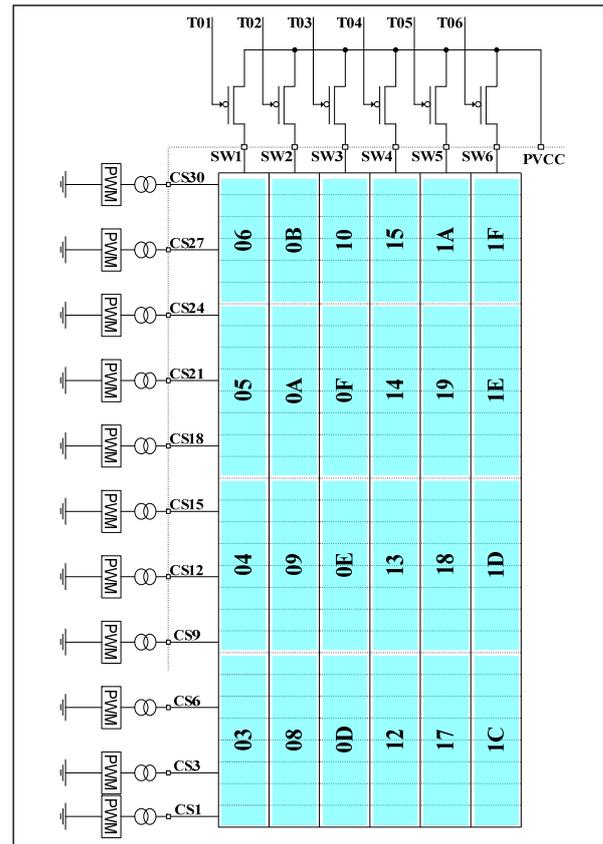


Figure 11 Open/Short Register

3Fh Reset Register

Once user writes the Reset Register with 0xAE, IS31FL3742 will reset all the IS31FL3742 registers to their default value. On initial power-up, the IS31FL3742 registers are reset to their default values for a blank display.

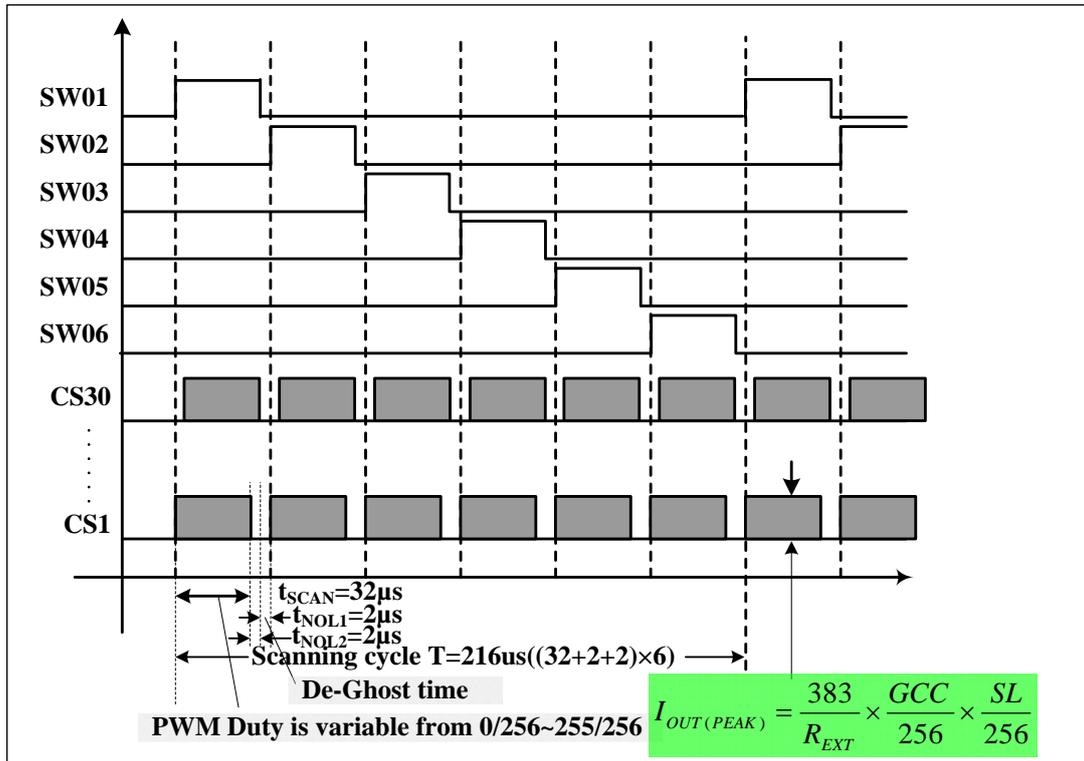


Figure 12 Scanning Timing

SCANING TIMING

As shown in Figure 12, the SW1~SW6 is turned on by serial, LED is driven 6 by 6 within the SWx (x=1~6) on time (SWx, x=1~6) is sink and pull low when LED on, including the non-overlap blanking time during scan, the duty cycle of SWx (active low, x=1~6) is:

$$Duty = \frac{32\mu s}{(32\mu s + 2\mu s + 2\mu s)} \times \frac{1}{6} = \frac{1}{6.75} \quad (2)$$

Where 32µs is t_{SCAN} , the period of scanning and 2µs is t_{NOL1} and t_{NOL2} , the non-overlap time and CSx delay time.

PWM CONTROL

After setting the I_{OUT} and GCC, the brightness of each LEDs (LED average current (I_{LED})) can be modulated with 256 steps by PWM Register, as described in Formula (1).

$$I_{LED} = \frac{PWM}{256} \times I_{OUT(PEAK)} \times Duty \quad (1)$$

Where PWM is PWM Registers (PG0, 00h~B3h) data showing in Table 8.

For example, in Figure 1, if $R_{EXT} = 10k\Omega$, PWM = 255, and GCC = 0xFF, Scaling = 0xFF, then

$$I_{OUT(PEAK)} = \frac{383}{10k\Omega} \times \frac{255}{256} \times \frac{255}{256} = 38mA$$

$$I_{LED} = 38mA \times \frac{1}{6.75} \times \frac{PWM}{256}$$

Writing new data continuously to the registers can modulate the brightness of the LEDs to achieve a breathing effect.

GAMMA CORRECTION

In order to perform a better visual LED breathing effect we recommend using a gamma corrected PWM value to set the LED intensity. This results in a reduced number of steps for the LED intensity setting, but causes the change in intensity to appear more linear to the human eye.

Gamma correction, also known as gamma compression or encoding, is used to encode linear luminance to match the non-linear characteristics of display. Since the IS31FL3742 can modulate the brightness of the LEDs with 256 steps, a gamma correction function can be applied when computing each subsequent LED intensity setting such that the changes in brightness matches the human eye's brightness curve.

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Table 21 32 Gamma Steps with 256 PWM Steps

| | | | | | | | |
|-------|-------|-------|-------|-------|-------|-------|-------|
| C(0) | C(1) | C(2) | C(3) | C(4) | C(5) | C(6) | C(7) |
| 0 | 1 | 2 | 4 | 6 | 10 | 13 | 18 |
| C(8) | C(9) | C(10) | C(11) | C(12) | C(13) | C(14) | C(15) |
| 22 | 28 | 33 | 39 | 46 | 53 | 61 | 69 |
| C(16) | C(17) | C(18) | C(19) | C(20) | C(21) | C(22) | C(23) |
| 78 | 86 | 96 | 106 | 116 | 126 | 138 | 149 |
| C(24) | C(25) | C(26) | C(27) | C(28) | C(29) | C(30) | C(31) |
| 161 | 173 | 186 | 199 | 212 | 226 | 240 | 255 |

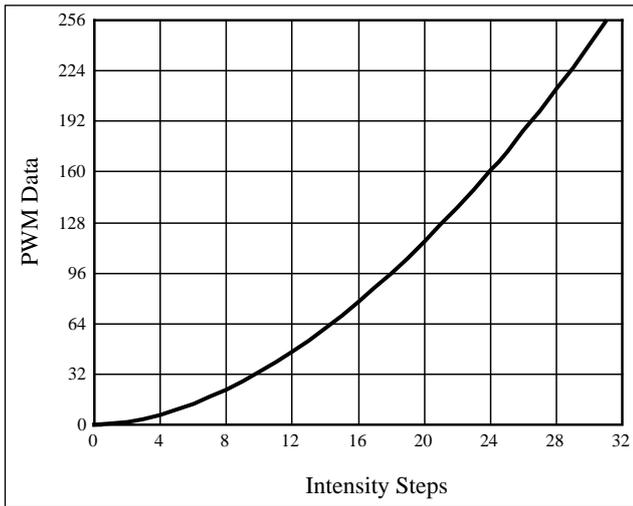


Figure 13 Gamma Correction (32 Steps)

Choosing more gamma steps provides for a more continuous looking breathing effect. This is useful for very long breathing cycles. The recommended configuration is defined by the breath cycle T. When T=1s, choose 32 gamma steps, when T=2s, choose 64 gamma steps. The user must decide the final number of gamma steps not only by the LED itself, but also based on the visual performance of the finished product.

Table 22 64 Gamma Steps with 256 PWM Steps

| | | | | | | | |
|-------|-------|-------|-------|-------|-------|-------|-------|
| C(0) | C(1) | C(2) | C(3) | C(4) | C(5) | C(6) | C(7) |
| 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| C(8) | C(9) | C(10) | C(11) | C(12) | C(13) | C(14) | C(15) |
| 8 | 10 | 12 | 14 | 16 | 18 | 20 | 22 |
| C(16) | C(17) | C(18) | C(19) | C(20) | C(21) | C(22) | C(23) |
| 24 | 26 | 29 | 32 | 35 | 38 | 41 | 44 |
| C(24) | C(25) | C(26) | C(27) | C(28) | C(29) | C(30) | C(31) |
| 47 | 50 | 53 | 57 | 61 | 65 | 69 | 73 |
| C(32) | C(33) | C(34) | C(35) | C(36) | C(37) | C(38) | C(39) |
| 77 | 81 | 85 | 89 | 94 | 99 | 104 | 109 |
| C(40) | C(41) | C(42) | C(43) | C(44) | C(45) | C(46) | C(47) |
| 114 | 119 | 124 | 129 | 134 | 140 | 146 | 152 |
| C(48) | C(49) | C(50) | C(51) | C(52) | C(53) | C(54) | C(55) |
| 158 | 164 | 170 | 176 | 182 | 188 | 195 | 202 |
| C(56) | C(57) | C(58) | C(59) | C(60) | C(61) | C(62) | C(63) |
| 209 | 216 | 223 | 230 | 237 | 244 | 251 | 255 |

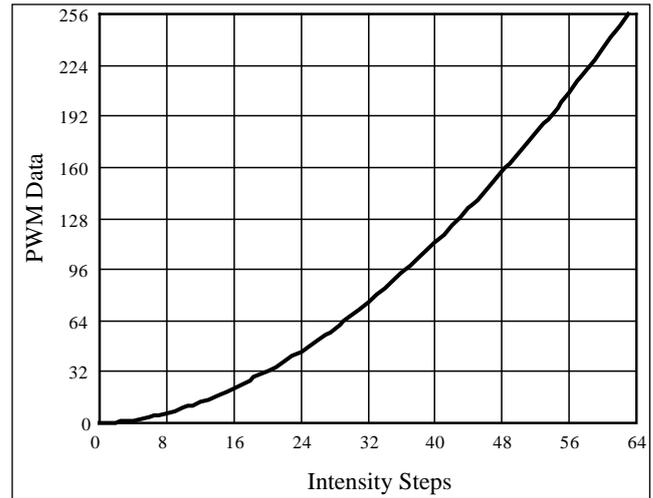


Figure 14 Gamma Correction (64 Steps)

Note: The data of 32 gamma steps is the standard value and the data of 64 gamma steps is the recommended value.

OPERATING MODE

PWM Mode

IS31FL3742 can only operate in PWM Mode. The brightness of each LED can be modulated with 256 steps by PWM registers. For example, if the data in PWM Register is "0000 0100", then the PWM is the fourth step.

Writing new data continuously to the registers can modulate the brightness of the LEDs to achieve a breathing effect.

DE-GHOST FUNCTION

The "ghost" term is used to describe the behavior of an LED that should be OFF but instead glows dimly when another LED is turned ON. A ghosting effect typically can occur when multiplexing LEDs. In matrix architecture any parasitic capacitance found in the constant-current outputs or the PCB traces to the LEDs may provide sufficient current to dimly light an LED to create a ghosting effect.

To prevent this LED ghost effect, the IS31FL3742 has integrated pull down resistors for each SWx (x=1~6) and pull up resistors for each CSy (y=1~30). Select the right SWx pull down resistor (PG4, 02h) and CSy pull up resistor (PG4, 02h) which eliminates the ghost LED for a particular matrix layout configuration.

Typically, selecting the 32kΩ will be sufficient to eliminate the LED ghost phenomenon.

The SWx pull down resistors and CSy pull up resistors are active only when the CSy/SWx output working the OFF state and therefore no power is lost through these resistors

SHUTDOWN MODE

Shutdown mode can be used as a means of reducing power consumption. During shutdown mode all registers retain their data.

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Software Shutdown

By setting SSD bit of the Configuration Register (PG4, 00h) to “0”, the IS31FL3742 will operate in software shutdown mode. When the IS31FL3742 is in software shutdown, all current sources are switched off, so that the matrix is blanked. All registers can be operated. Typical current consume is 2 μ A.

Hardware Shutdown

The chip enters hardware shutdown when the SDB pin is pulled low. All analog circuits are disabled during hardware shutdown, typical the current consume is 2 μ A.

The chip releases hardware shutdown when the SDB pin is pulled high. When set SDB high, the rising edge will reset the I2C module, but the register information retains. During hardware shutdown state Function Register can be operated.

If VCC has risk drop below 1.75V but above 0.1V during SDB pulled low, please re-initialize all Function Registers before SDB pulled high.

LAYOUT

As described in external resistor (R_{EXT}), the chip consumes lots of power. Please consider below factors when layout the PCB.

1. The VCC (PVCC, AVCC) capacitors need to close to the chip and the ground side should well connect to the GND of the chip.
2. R_{EXT} should be close to the chip and the ground side should well connect to the GND of the chip.
3. The thermal pad should connect to ground pins and the PCB should have the thermal pad too, usually this pad should have 16 or 25 via thru the PCB to other side's ground area to help radiate the heat. About the thermal pad size, please refer to the land pattern of each package.
4. The CSy pins maximum current is 38mA ($R_{EXT}=10k\Omega$), and the SWx pins maximum current is larger, the width of the trace, SWx should have wider trace than CSy.

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CLASSIFICATION REFLOW PROFILES

| Profile Feature | Pb-Free Assembly |
|---|----------------------------------|
| Preheat & Soak Temperature min (T _{smin}) Temperature max (T _{smax}) Time (T _{smin} to T _{smax}) (t _s) | 150°C 200°C 60-120 seconds |
| Average ramp-up rate (T _{smax} to T _p) | 3°C/second max. |
| Liquidous temperature (T _L) Time at liquidous (t _L) | 217°C 60-150 seconds |
| Peak package body temperature (T _p)* | Max 260°C |
| Time (t _p)** within 5°C of the specified classification temperature (T _c) | Max 30 seconds |
| Average ramp-down rate (T _p to T _{smax}) | 6°C/second max. |
| Time 25°C to peak temperature | 8 minutes max. |

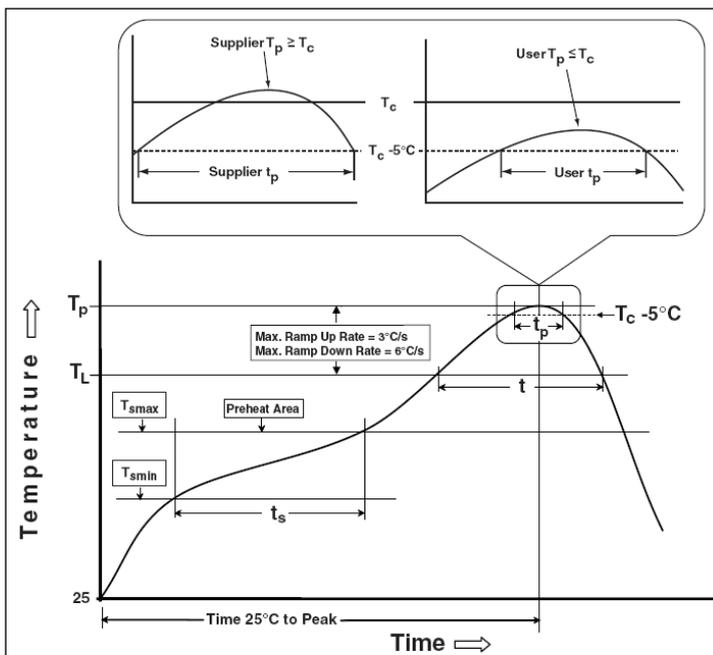
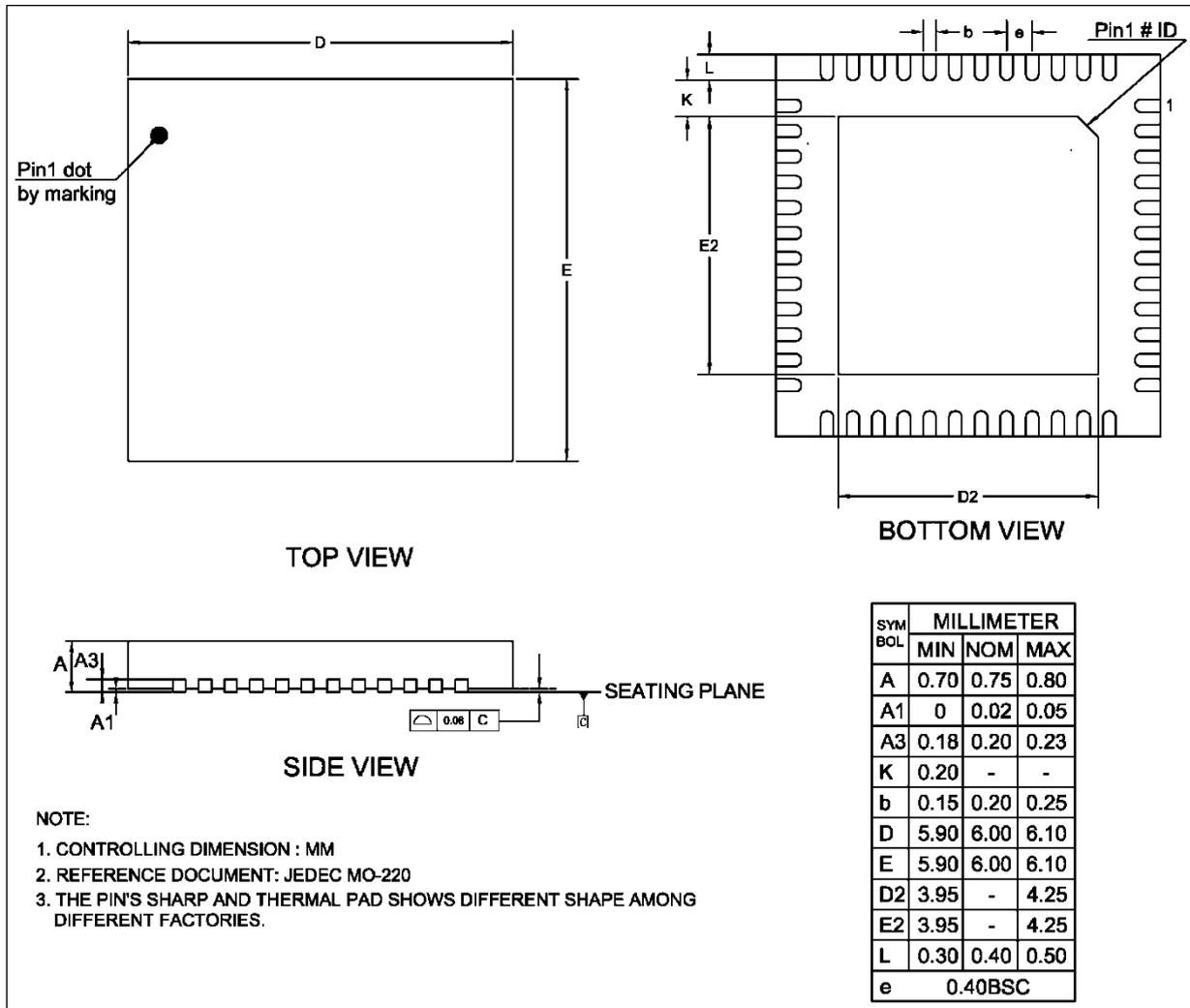


Figure 19 Classification Profile

IS31FL3742

PACKAGE INFORMATION

QFN-48



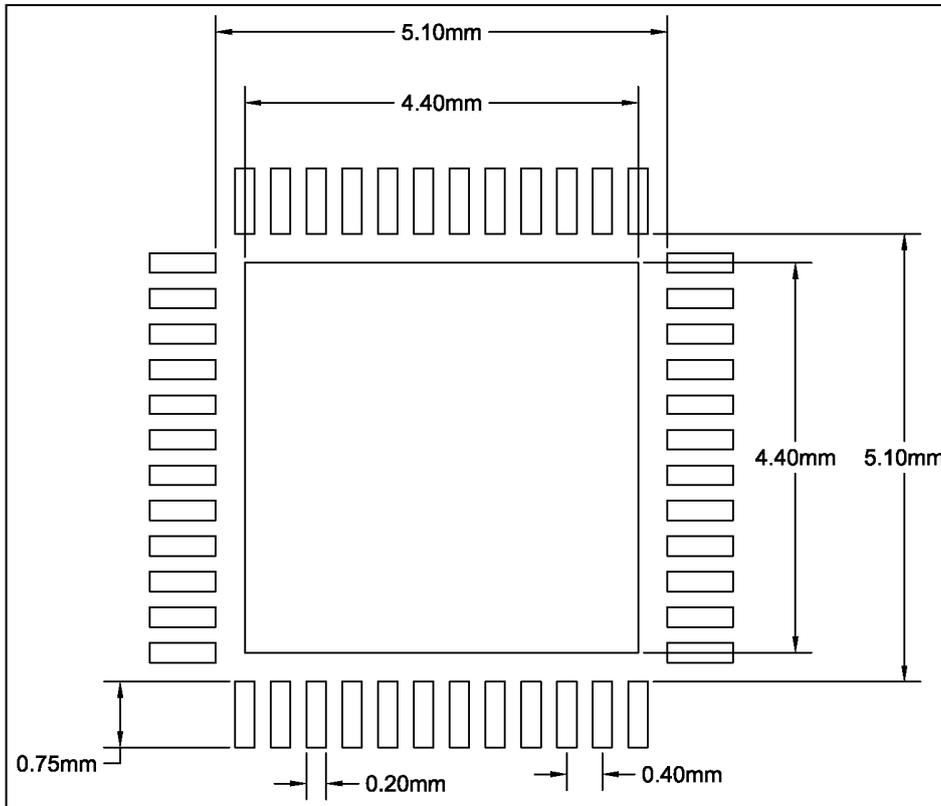
NOTE:

1. CONTROLLING DIMENSION : MM
2. REFERENCE DOCUMENT: JEDEC MO-220
3. THE PIN'S SHARP AND THERMAL PAD SHOWS DIFFERENT SHAPE AMONG DIFFERENT FACTORIES.

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RECOMMENDED LAND PATTERN

QFN-48



Note:

1. Land pattern complies to IPC-7351.
2. All dimensions in MM.
3. This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown (eg. user's board manufacturing specs), user must determine suitability for use.



IS31FL3742

REVISION HISTORY

| Revision | Detail Information | Date |
|----------|---|------------|
| 0A | Initial release. | 2017.06.03 |
| 0B | 1. Update the I_{LED} formula 2. Update Land Pattern and θ_{JA} | 2017.07.17 |
| 0C | 1. Update Logic Electrical Characteristics Table | 2017.09.06 |
| 0D | 1. Update ESD value 2. Add SDB reset function description | 2017.10.20 |
| A | Release to mass production | 2017.12.13 |